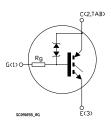




5 A, 1200 V, low drop internally clamped IGBT





Features

- Low on-voltage drop (V_{CE(sat)})
- · High current capability
- · High voltage clamping

Applications

· Low switching frequency applications

Description

This device is low drop internally clamped IGBT developed using advanced PowerMESH technology. This process guarantees an excellent trade-off between switching performance and low on-state behavior.



Product status link

STGD5NB120SZ

Product summary				
Order code STGD5NB120SZT4				
Marking GD5NB120SZ				
Package DPAK				
Packing	Tape and reel			



1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0 V)	1200	V
I.	Continuous collector current at T _C = 25 °C	10	•
Ic	Continuous collector current at T _C = 100 °C	5	Α
I _{CP} (1)	Pulsed collector current	10	Α
I _{CL} (2)	Turn-off latching current	10	Α
V _{GE}	Gate-emitter voltage	±20	V
V _{ECR}	Emitter-collector voltage	20	V
P _{TOT}	Total power dissipation at T _C = 25 °C	75	W
T _J	Operating junction temperature range	-55 to 150	°C
T _{stg}	Storage temperature range	-55 (0 150	C

^{1.} Pulse width is limited by maximum junction temperature

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance, junction-to-case	1.67	°C/W
R _{thJA}	Thermal resistance, junction-to-ambient	100	°C/W

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^{2.} $V_{CLAMP} = 80\% \ V_{CES}, \ V_{GE} = 15 \ V, \ R_G = 10 \ \Omega, \ T_J = 150 \ ^{\circ}C$



2 Electrical characteristics

 T_C = 25 °C unless otherwise specified

Table 3. Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage	V _{GE} = 0 V, I _C = 10 mA	1200			V
V	Collector-emitter saturation	V _{GE} = 15 V, I _C = 5 A		1.3	2.0	V
V _{CE(sat)}	voltage	V _{GE} = 15 V, I _C = 5 A, T _C = 125 °C		1.2		V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 250 \mu A$	2		5	V
$V_{\sf GE}$	Gate emitter voltage	V_{CE} = 2.5 V, I_{C} = 2 A, T_{C} = 25 to 125 °C			6.5	V
lana		V _{GE} = 0 V, V _{CE} = 900 V			50	μA
ICES	Collector cut-off current	$V_{GE} = 0 \text{ V}, V_{CE} = 900 \text{ V}, T_{C} = 125 ^{\circ}\text{C}^{(1)}$			250	μA
I _{GES}	Gate-emitter leakage current	V _{GE} = ±20 V, V _{CE} = 0 V			±100	nA
R_{G}	Gate resistance			4		kΩ

^{1.} Defined by design, not subject to production test.

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies}	Input capacitance		-	430	-	
C _{oes}	Output capacitance	V_{CE} = 25 V, f = 1 MHz, V_{GE} = 0 V	-	40	-	pF
C _{res}	Reverse transfer capacitance		-	7	-	

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Table 5. Switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{CC} = 960 \text{ V, } I_{C} = 5 \text{ A, } R_{G} = 1 \text{ k}\Omega,$	-	690	-	no
t _r	Current rise time	$V_{GE} = 15 \text{ V (see Figure 16. Switching waveform)}$ $V_{CC} = 960 \text{ V, } I_{C} = 5 \text{ A, } R_{G} = 1 \text{ k}\Omega,$ $V_{GE} = 15 \text{ V, } T_{J} = 125 \text{ °C}$ $(\text{see Figure 16. Switching waveform)}$ $V_{CC} = 960 \text{ V, } I_{C} = 5 \text{ A, } R_{G} = 1 \text{ k}\Omega,$ $V_{GE} = 15 \text{ V (see Figure 16. Switching waveform)}$	-	170	-	ns
(di/dt) _{on}	Turn-on current slope	waveform)	-	39.6	-	A/µs
t _{d(on)}	Turn-on delay time	Voc = 960 V Io = 5 A Ro = 1 kO	-	600	_	no
t _r	Current rise time	V _{GE} = 15 V, T _J = 125 °C	-	185	-	ns
(di/dt) _{on}	Turn-on current slope	(see Figure 16. Switching waveform)	-	39	-	A/µs
t _c	Cross-over time		-	4	_	
$t_r(V_{off})$	Off voltage rise time	00	-	2.2	-	
t _d (off)	Turn-off delay time		-	12.1	-	
t _f	Current fall time		-	1.13	-	
t _c	Cross-over time		-	5	-	μs
$t_r(V_{off})$	Off voltage rise time	$V_{CC} = 960 \text{ V}, I_C = 5 \text{ A}, R_G = 1 \text{ k}\Omega,$	-	2.2	-	
t _d (off)	Turn-off delay time	V _{GE} = 15 V, T _J = 125 °C (see Figure 16. Switching waveform)	-	12.1	-	
t _f	Current fall time		-	2	-	

Table 6. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} (1)	Turn-on switching energy	$V_{CC} = 960 \text{ V}, I_{C} = 5 \text{ A}, R_{G} = 1 \text{ k}\Omega,$	-	2.59	-	
E _{off} (2)	Turn-off switching energy	V _{GE} = 15 V (see Figure 16. Switching		9	-	mJ
E _{ts}	Total switching energy	waveform)	-	11.59	-	
E _{on} (1)	Turn-on switching energy	V _{CC} = 960 V, I _C = 5 A, R _G = 1	-	2.64	-	
E _{off} (2)	Turn-off switching energy	$k\Omega$, V_{GE} = 15 V, T_J = 125 °C	-	10.2	-	mJ
E _{ts}	Total switching energy	(see Figure 16. Switching waveform)	-	12.68	-	

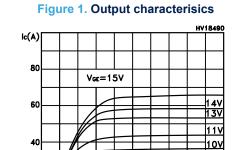
^{1.} Including the reverse recovery of the diode.

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^{2.} Including the tail of the collector current.



2.1 Electrical characteristics (curves)



20

8V 7V

6V 5V Vcε(V)

Figure 2. Transfer characteristics

Ic(A)

Vce=25V

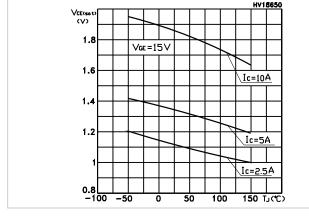
80

40

20

3 6 9 12 Voe(V)

Figure 3. Collector-emitter on voltage vs temperature



Voe(V) HV18670

Figure 4. Gate charge vs gate-source voltage

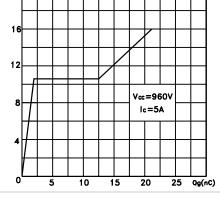


Figure 5. Capacitance variations

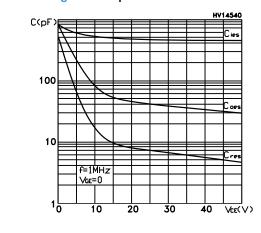
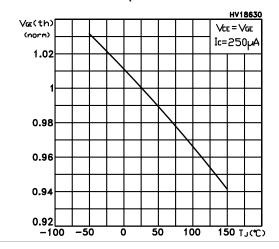


Figure 6. Normalized gate threshold voltage vs temperature



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Figure 7. Collector-emitter on voltage vs collector current

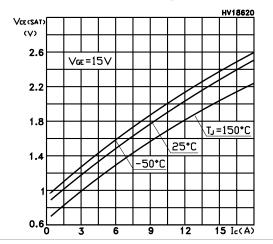


Figure 8. Breakdown voltage vs temperature

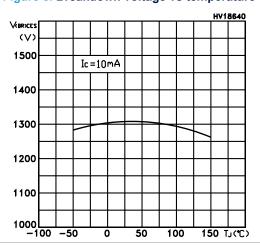


Figure 9. Normalized collector-emitter on voltage vs temperature

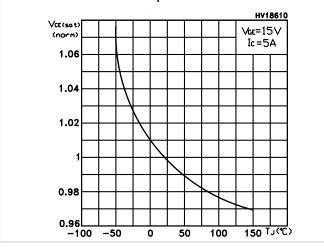


Figure 10. Switching energy vs gate resistance

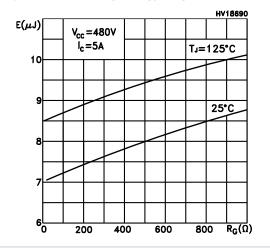


Figure 11. Switching energy vs collector current

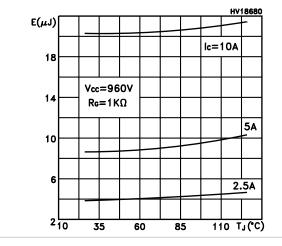
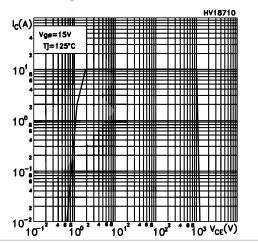
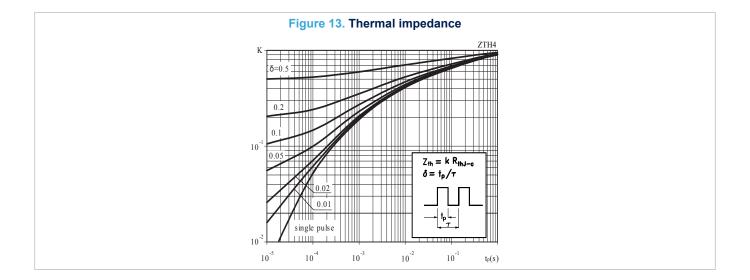


Figure 12. Turn-off SOA



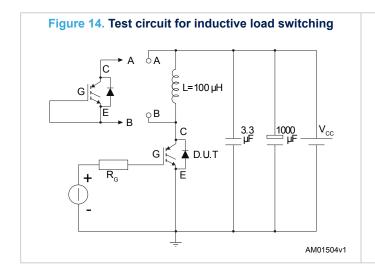
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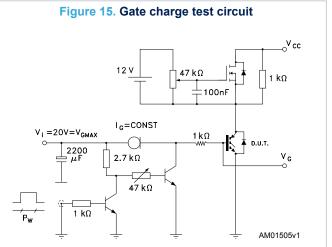


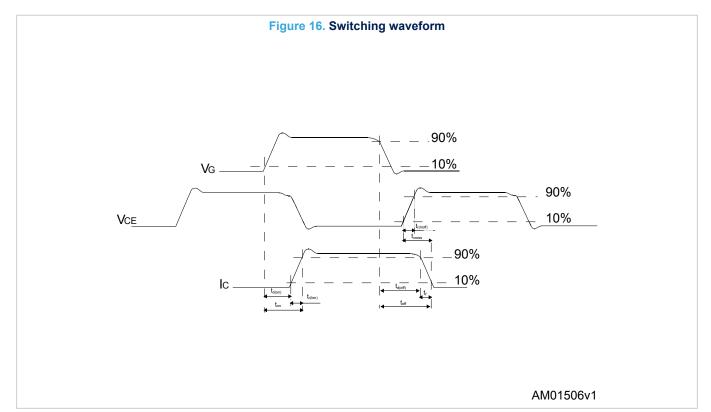




3 Test circuits







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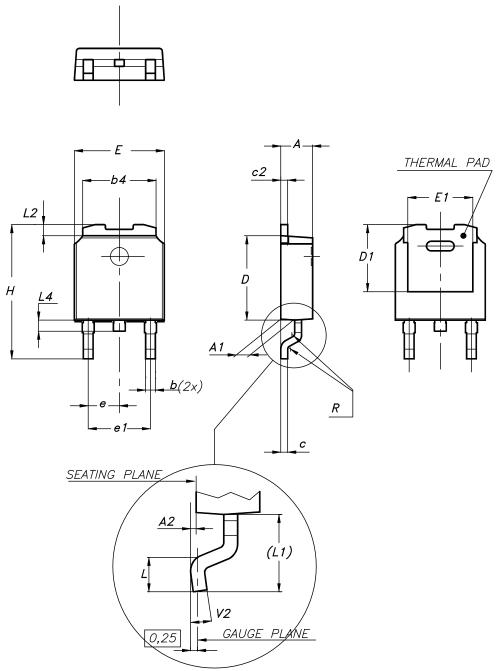


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 DPAK (TO-252) type A2 package information

Figure 17. DPAK (TO-252) type A2 package outline



0068772_type-A2_rev30



Table 7. DPAK (TO-252) type A2 mechanical data

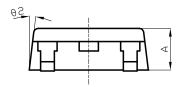
Dim.	mm					
Dilli.	Min.	Тур.	Max.			
А	2.20		2.40			
A1	0.90		1.10			
A2	0.03		0.23			
b	0.64		0.90			
b4	5.20		5.40			
С	0.45		0.60			
c2	0.48		0.60			
D	6.00		6.20			
D1	4.95	5.10	5.25			
E	6.40		6.60			
E1	5.10	5.20	5.30			
е	2.159	2.286	2.413			
e1	4.445	4.572	4.699			
Н	9.35		10.10			
L	1.00		1.50			
L1	2.60	2.80	3.00			
L2	0.65	0.80	0.95			
L4	0.60		1.00			
R		0.20				
V2	0°		8°			

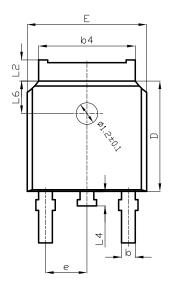
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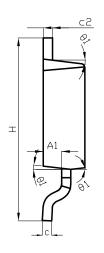


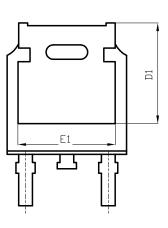
4.2 DPAK (TO-252) type C2 package information

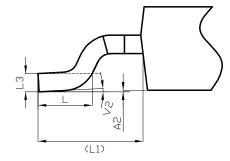
Figure 18. DPAK (TO-252) type C2 package outline











0068772_type-C2_rev30

Downloaded from Arrow.com.



Table 8. DPAK (TO-252) type C2 mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
А	2.20	2.30	2.38
A1	0.90	1.01	1.10
A2	0.00		0.10
b	0.72		0.85
b4	5.13	5.33	5.46
С	0.47		0.60
c2	0.47		0.60
D	6.00	6.10	6.20
D1	5.10		5.60
Е	6.50	6.60	6.70
E1	5.20		5.50
е	2.186	2.286	2.386
Н	9.80	10.10	10.40
L	1.40	1.50	1.70
L1		2.90 REF	
L2	0.90		1.25
L3		0.51 BSC	
L4	0.60	0.80	1.00
L6		1.80 BSC	
θ1	5°	7°	9°
θ2	5°	7°	9°
V2	0°		8°

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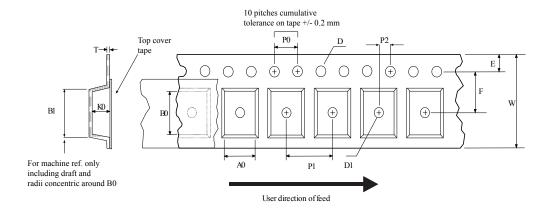
Figure 19. DPAK (TO-252) recommended footprint (dimensions are in mm)

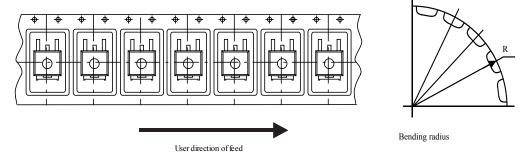
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4.3 DPAK (TO-252) packing information

Figure 20. DPAK (TO-252) tape outline



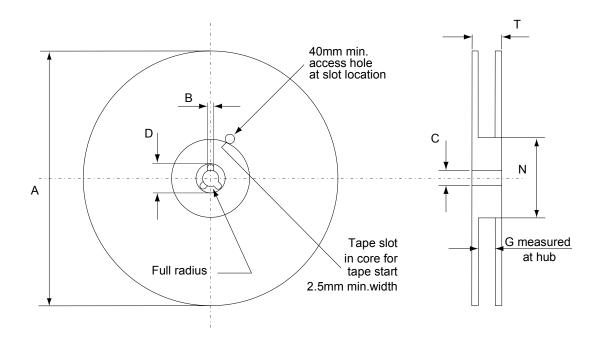


AM08852v1

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Figure 21. DPAK (TO-252) reel outline



AM06038v1

Table 9. DPAK (TO-252) tape and reel mechanical data

	Tape			Reel		
Dim.	n	mm Dim.		mm		nm
Dim.	Min.	Max.	Dim.	Min.	Max.	
A0	6.8	7	Α		330	
В0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
E	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1	Base	qty.	2500	
P1	7.9	8.1	Bulk	qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

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Revision history

Table 10. Document revision history

Date	Revision	Changes
06-Oct-2003	5	No history because migration
18-Jan-2005	6	Final datasheet
13-Nov-2008	7	Insert new value in Table 2: Absolute maximum ratings
08-Jan-2019	8	The document status is production data. Updated Section 4 Package information.
		Minor text changes.
15-Jun-2021	9	Removed IPAK package and document updated accordingly. Modified applications section on cover page. Modified Table 1. Absolute maximum ratings. Removed Table 7: Functional test. Minor text changes.





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